## IGBT 600V, 10A, N-Channel



**Electrical Connection** 

N-Channel

1:Gate 2:Collector

DPAK

3:Emitter 4:Collector

#### Features

- Reverse Conducting II IGBT
- IGBT V<sub>CE</sub>(sat)=1.7V (typ) [I<sub>C</sub>=10A, V<sub>GE</sub>=15V]
- IGBT tf=65ns (typ)
- Diode V<sub>F</sub>=1.5V (typ) [I<sub>F</sub>=10A]
- Diode t<sub>rr</sub>=90ns (typ)
- 5µs Short Circuit Capability

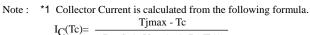
#### Applications

• General Purpose Inverter

#### **Specifications**

Absolute Maximum Ratings at Ta=25°C, Unless otherwise specified

Parameter		Symbol	Value	Unit
Collector to Emitter Voltage		VCES	600	V
Gate to Emitter Voltage		VGES	±20	V
Collector Current (DC)	@Tc=25°C *2	1- 1	20	А
Limited by Tjmax	@Tc=100°C *2	IC *1	10	А
Collector Current (Peak)		ICP	10	А
Pulse width Llimited by Tjmax			40	A
Diode Average Output Current		IO	10	А
Power Dissipation		PD	70	14/
Tc=25°C (Our ideal heat dissipation condition) $*^2$			72	W
Junction Temperature	Тј	175	°C	
Storage Temperature		Tstg	-55 to +175	°C



$$= \frac{P_{th}(j-c) \times V_{CE}(sat) (I_C(Tc))}{R_{th}(j-c) \times V_{CE}(sat) (I_C(Tc))}$$

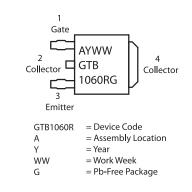
\*2 Our condition is radiation from backside. The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminum.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.





#### **Electrical Characteristics** at Ta=25°C, Unless otherwise specified

Parameter	Cumbal	Canditi			Value		
Parameter	Symbol	Conditions		min	typ	max	Unit
Collector to Emitter Breakdown Voltage	V(BR)CES	I <sub>C</sub> =1mA, V <sub>GE</sub> =0V		600			V
Collector to Emitter Cut off Current	ICES	V <sub>CE</sub> =600V, V <sub>GE</sub> =0V	Tc=25°C			10	μA
			Tc=150°C			1	mA
Gate to Emitter Leakage Current	IGES	V <sub>GE</sub> =±20V, V <sub>CE</sub> =0V				±100	nA
Gate to Emitter Threshold Voltage	V <sub>GE</sub> (th)	V <sub>CE</sub> =20V, I <sub>C</sub> =160µА		4.5		7.0	V
Collector to Emitter Saturation Voltage	V <sub>CE</sub> (sat)	V <sub>GE</sub> =15V, I <sub>C</sub> =10A	Tc=25°C		1.7	2.1	V
			Tc=100°C		1.9	2.3	V
Forward Diode Voltage	VF	IF=10A			1.5	2.1	V
Input Capacitance	Cies	V <sub>CE</sub> =20V, f=1MHz			1340		pF
Output Capacitance	Coes				45		pF
Reverse Transfer Capacitance	Cres				33		pF
Turn-ON Delay Time	t <sub>d</sub> (on)				48		ns
Rise Time	tr				34		ns
Turn-ON Time	ton	V <sub>CC</sub> =300V, I <sub>C</sub> =10A R <sub>G</sub> =30Ω, L=500μH V <sub>G</sub> F=0V/15V		188		ns	
Turn-OFF Delay Time	t <sub>d</sub> (off)			120		ns	
Fall Time	tf	Vclamp=400V Tc=25°C See Fig.1, See Fig.2			65		ns
Turn-OFF Time	toff				220		ns
Turn-ON Energy	Eon				412		μJ
Turn-OFF Energy	Eoff				140		μJ
Total Gate Charge	Qg	V <sub>CE</sub> =300V, V <sub>GE</sub> =15V, I <sub>C</sub> =10A			53		nC
Gate to Emitter Charge	Qge				10		nC
Gate to Collector "Miller" Charge	Qgc				25		nC
Diode Reverse Recovery Time	t <sub>rr</sub>	IF=10A,di/dt=300A/μs, V <sub>CC</sub> =300V, See Fig.3			90		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### Thermal Characteristics at Ta=25°C, Unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Thermal Resistance IGBT (Junction to Case)	Rth(j-c) (IGBT)	Tc=25°C (Our ideal heat dissipation condition) * <sup>2</sup>	2.07	°C/W
Thermal Resistance (Junction to Ambient)	Rth(j-a)		100	°C/W

Note : \*2 Our condition is radiation from backside.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminum.

13V

11V

9V

13V

11V

9V

18

18

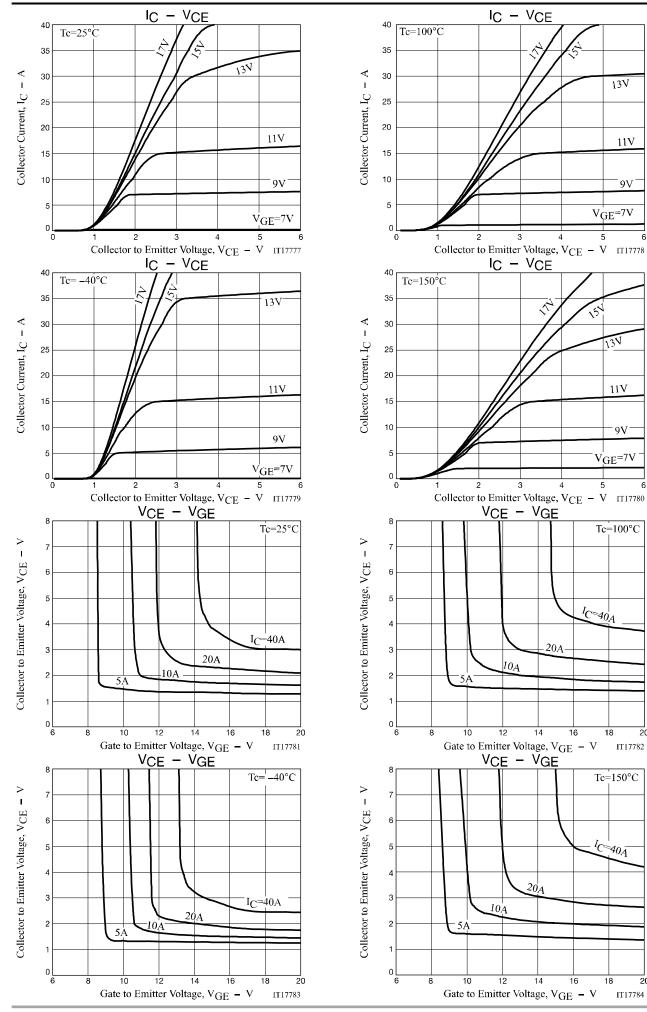
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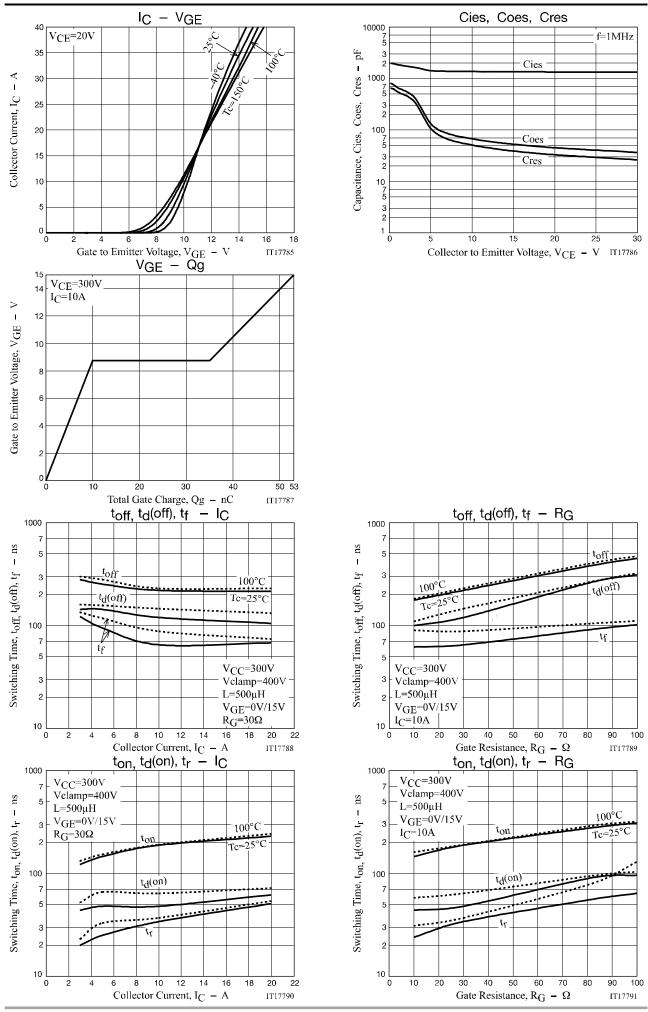
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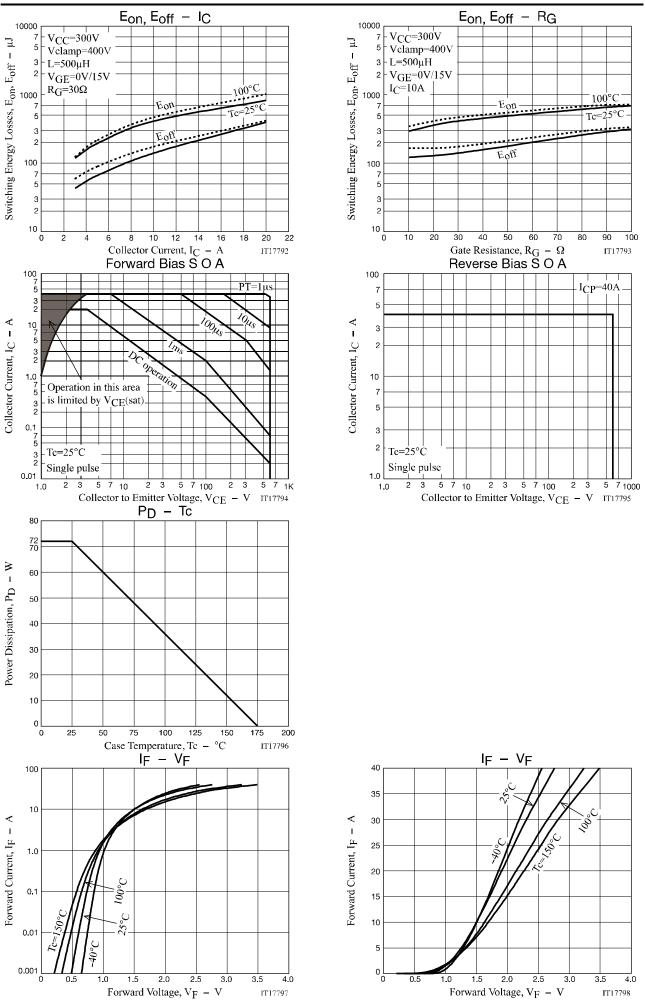
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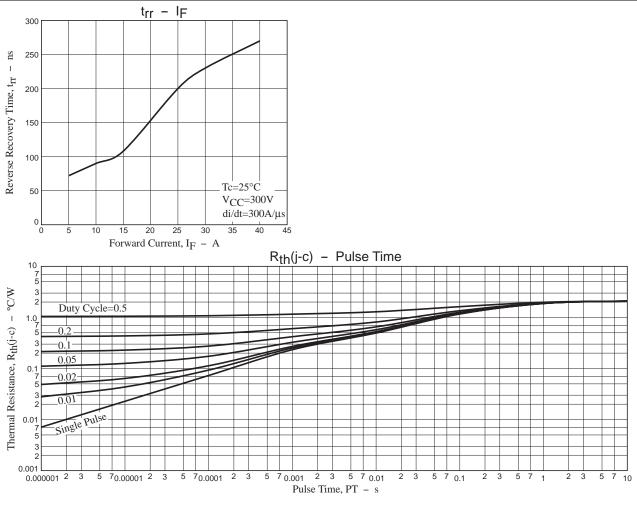
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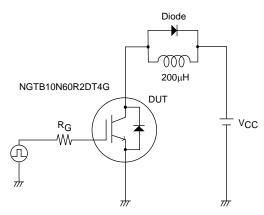
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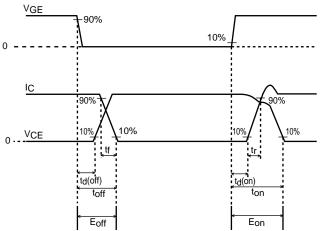
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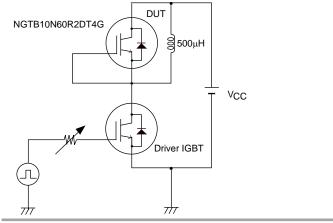
#### Fig.1 Switching Time Test Circuit



#### Fig.2 Timing Chart



#### Fig.3 Reverse Recovery Time Test Circuit



MILLIMETERS

 MIN
 MAX

 2.18
 2.38

1.14

0.00 0.13

4.57 5.46 0.46 0.61

0.46 0.61

5.97 6.22

6.35 6.73

2.29 BSC 9.40 10.41

2.90 REF 0.51 BSC

AYWW

Discrete

XXX XXXXXG

1.01

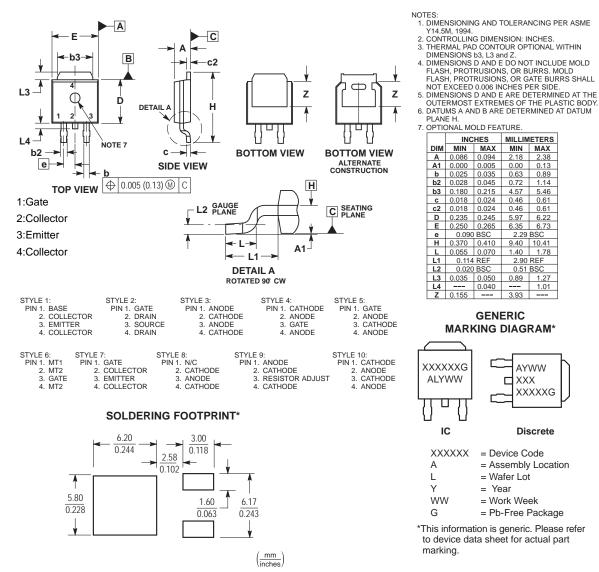
1.40 1.78

0.63 0.89

0.72

#### Package Dimensions

unit : mm DPAK (SINGLE GAUGE) CASE 369C ISSUE E



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### ORDERING INFORMATION

Device	Package	Shipping	note	
NGTB10N60R2DT4G	DPAK	2500 pcs. / reel	Pb-Free And Halogen Free	

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